

6427525 NEC ELECTRONICS INC

98D 18966 D7-39-11

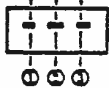
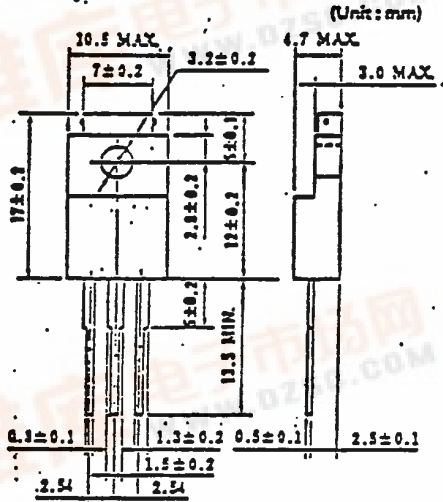
NEC
ELECTRON DEVICE

MOS FIELD EFFECT TRANSISTOR

2SK811

FAST SWITCHING
N-CHANNEL SILICON POWER MOS FET

PACKAGE DIMENSIONS



- 1. Gate
- 2. Drain
- 3. Source

Electrical Characteristics (Ta=25 °C)

Features

- Suitable for switching power supplies, actuator controls and pulse circuits
- 4V Gate Drive — Logic level —
- Large Current Switching : ID(DC)=12A
- Low RDS(on)
- No second breakdown

Absolute Maximum Ratings(Ta=25°C)

Drain to Source Voltage	V _{DSS}	100V
Gate to Source Voltage	V _{GSS}	± 20V
Continuous Drain Current	I _D (DC)	± 12A
Pulse Drain Current	I _D (pulse) *	± 48A
Total Power Dissipation	PT	2.0W
Total Power Dissipation	PT**	35W
Channel Temperature	T _{ch}	150 °C
Storage Temperature	T _{stg}	-55to+150 °C
	* T _{ch} ≤ 150 °C	
	** T _c = 25 °C	

Characteristics	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Drain Leakage Current	I _{DSS}			10	μA	V _D =100V, V _G S=0
Gate to Source Leakage Current	I _{GSS}			100	nA	V _G S= 20V, V _D S=0
Gate to Source Cutoff Voltage	V _G S(off)	1.0		2.5	V	V _D S=10V, I _D =1.0mA
Forward Transfer Admittance	y _{fs}	4.0	10		S	V _D S=10V, I _D =8.0A
Drain to Source On-State Resistance	R _D S(on)		0.1	0.18	Ω	V _G S=10V, I _D =8.0A
Drain to Source On-State Resistance	R _D S(on)		0.15	0.25	Ω	V _G S=4.0V I _D =8.0A
Input Capacitance	C _{iss}		1200		pF	V _D S= 10V,
Output Capacitance	C _{oss}		400		pF	V _G S=0,
Reverse Transfer Capacitance	C _{rss}		90		pF	f=1.0MHz
Turn-On Delay Time	t _d (on)		10		ns	I _D =8.0A,
Rise Time	t _r		20		ns	V _G S(on)= 10v,
Turn-Off Delay Time	t _d (off)		65		ns	V _{cc} = 40V,
Fall Time	t _f		55		ns	R _L = 5.0 Ω

NEC cannot assume any responsibility for any circuits shown or represent that they are free from patent infringement

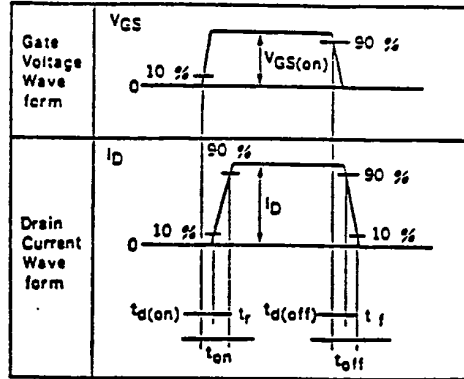
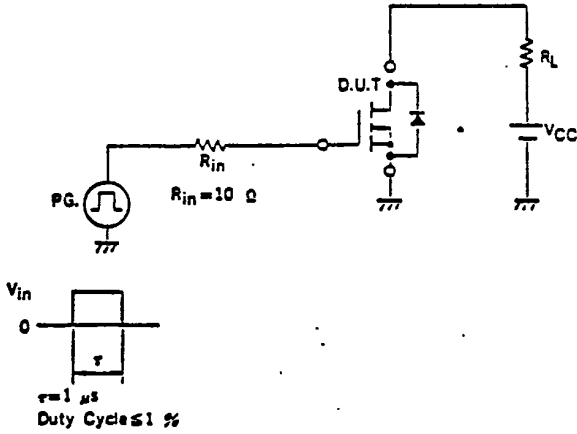


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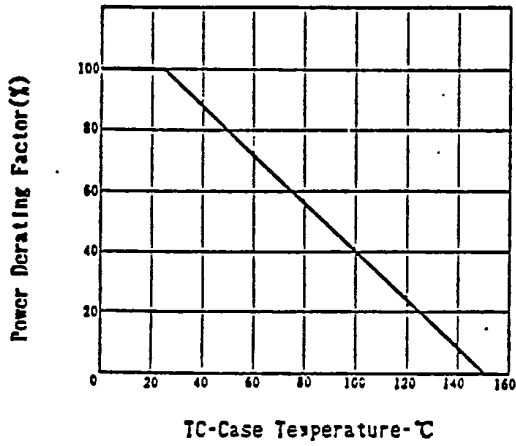
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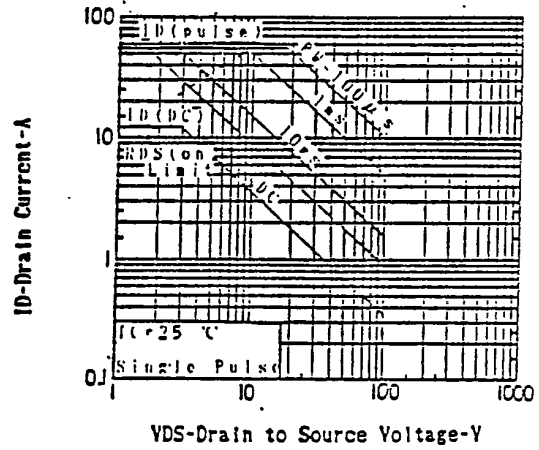
TURN-ON AND TURN-OFF TIME TEST CIRCUIT



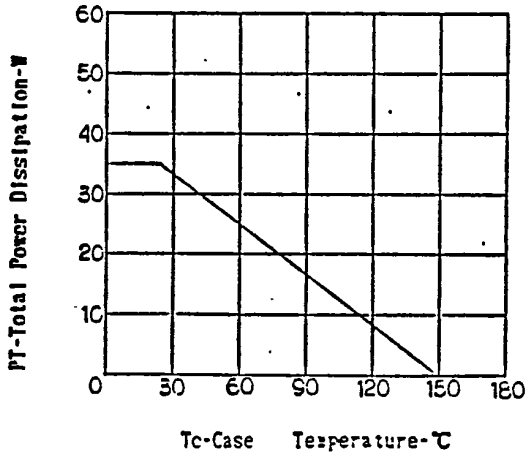
DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



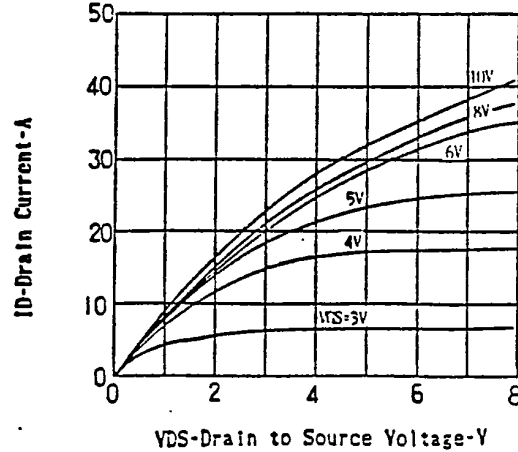
FORWARD BIAS SAFE OPERATING AREA



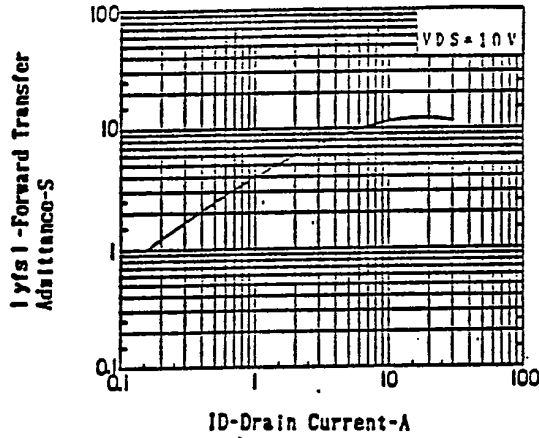
TOTAL POWER DISSIPATION vs. CASE TEMPERATURE



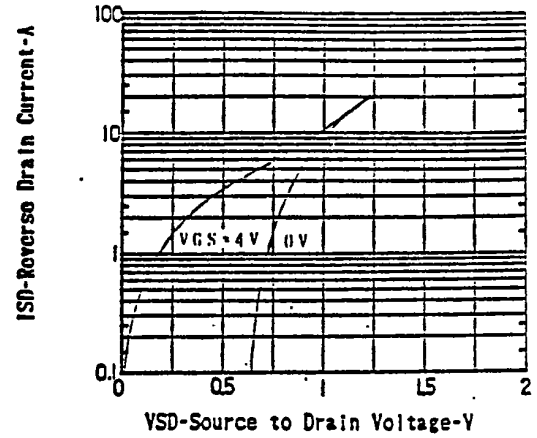
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



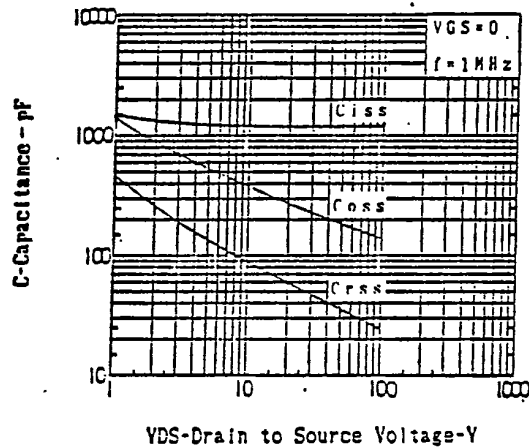
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



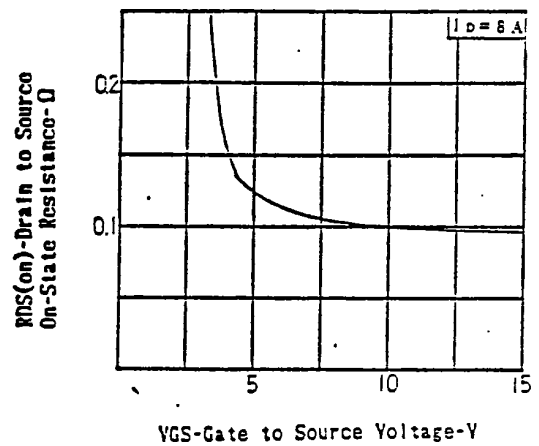
SOURCE TO DRAIN DIODE FORWARD VOLTAGE



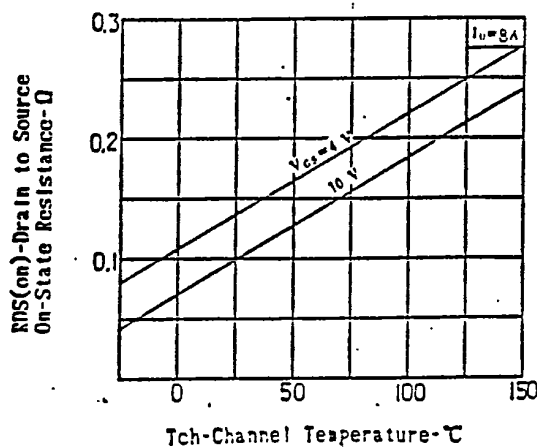
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



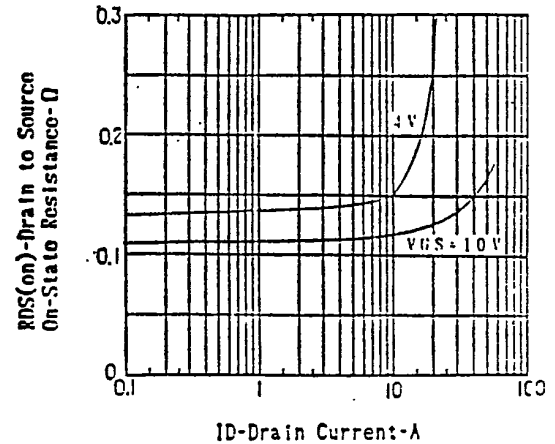
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



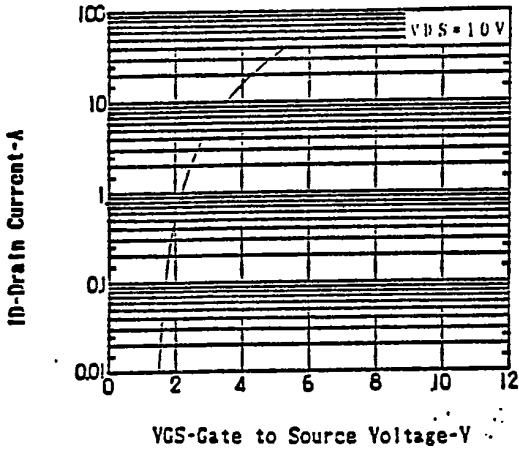
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



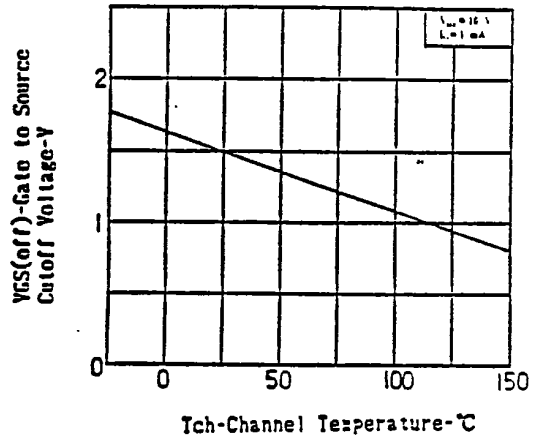
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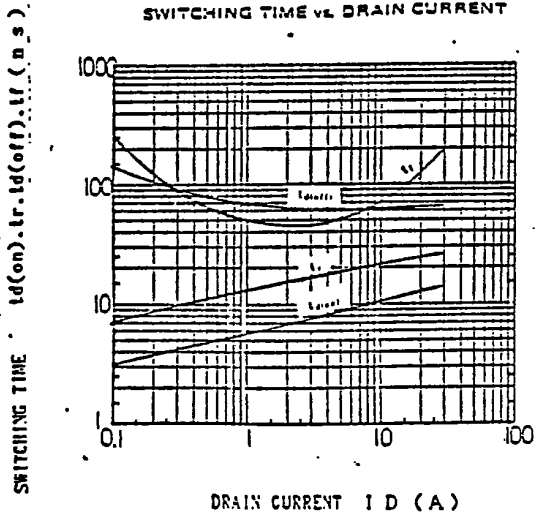
TRANSFER CHARACTERISTICS



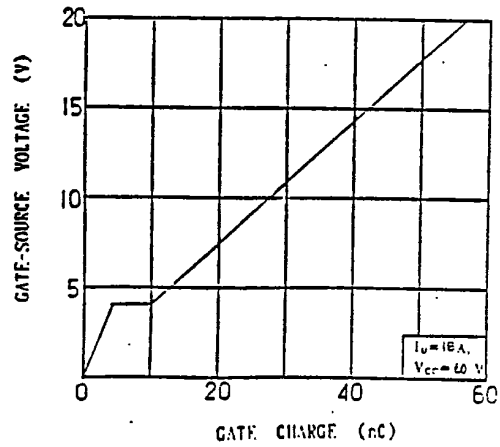
GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE



SWITCHING TIME vs. DRAIN CURRENT



GATE CHARGE VS GATE-SOURCE VOLTAGE



NORMALIZED TRANSIENT THERMAL IMPEDANCE vs. PULSE WIDTH

